

<u>AP2300BI</u>

20V N-Channel Enhancement Mode MOSFET

Description

The AP2300BI uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

V_{DS} = 20V I_D =2.8A

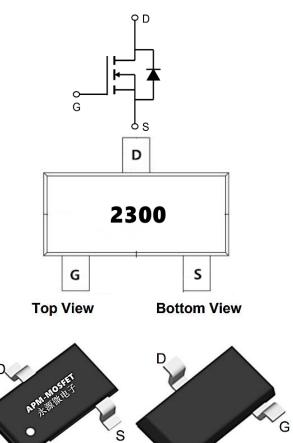
 $R_{DS(ON)} < 55m\Omega @ V_{GS} = 10V$ (Type: 48m Ω)

Application

Battery protection

Load switch

Uninterruptible power suppl



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP2300BI	SOT23L	2300	3000

Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units
Vds	Drain-Source Voltage	20	V
Vgs	Gate-Source Voltage	±12	V
ID@TA=25°C	Continuous Drain Current, V _{GS} @ 4.5V ¹	2.8	А
I _D @T _A =70°C	Continuous Drain Current, V _{GS} @ 4.5V ¹	1.6	А
Ы	Pulsed Drain Current ²	7.4	А
P _D @T _A =25°C	Total Power Dissipation ³	0.9	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R _{0JA}	Thermal Resistance Junction-ambient ¹	125	°C/W
Rejc	Thermal Resistance Junction-Case ¹	90	°C/W



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Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} =0V,I _D =250µA	20	22	-	V
IDSS	Zero Gate Voltage Drain Current	V _{DS} =20V, V _{GS} = 0V,	-	-	1.0	μA
IGSS	Gate to Body Leakage Current	V_{DS} =0V, V_{GS} = ±12V	-	-	±100	nA
VGS(th)	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D =250µA	0.4	0.6	1.2	V
		V _{GS} =4.5V, I _D =2A	-	42	50	0
RDS(on)	Static Drain-Source on-Resistance note2 -	V _{GS} =2.5V, I _D =1.5A	-	54	70	mΩ
C _{iss}	Input Capacitance		-	184	-	pF
Coss	Output Capacitance	V _{DS} =10V, V _{GS} =0V, f = 1.0MHz	-	38	-	pF
Crss	Reverse Transfer Capacitance		-	28	-	pF
Qg	Total Gate Charge		-	2.7	-	nC
Qgs	Gate-Source Charge	V _{DS} =10V, I _D =3A, V _{GS} =4.5V	-	0.4	-	nC
Q_{gd}	Gate-Drain("Miller") Charge		-	0.5	-	nC
td(on)	Turn-on Delay Time	V _{DS} =10V, I _D =3A, R _{GEN} =3Ω, V _{GS} =4.5V	-	2.3	-	ns
tr	Turn-on Rise Time		-	3.1	-	ns
td(off)	Turn-off Delay Time		-	9.2	-	ns
t _f	Turn-off Fall Time		-	2.5	-	ns
IS	Maximum Continuous Drain to Source Diode ForwardCurrent		-	-	3	А
ISM	Maximum Pulsed Drain to Source Diode Forward Current		-	-	12	А
VSD	Drain to Source Diode Forward Voltage	V _{GS} = 0V, I _S =3A	-	-	1.2	V

Note :

 $1_{\mbox{\tiny V}}$ The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

 $2\,{\scriptstyle \smallsetminus}\,$ The data tested by pulsed , pulse width $\leq 300 us$, duty cycle $\leq 2\%$

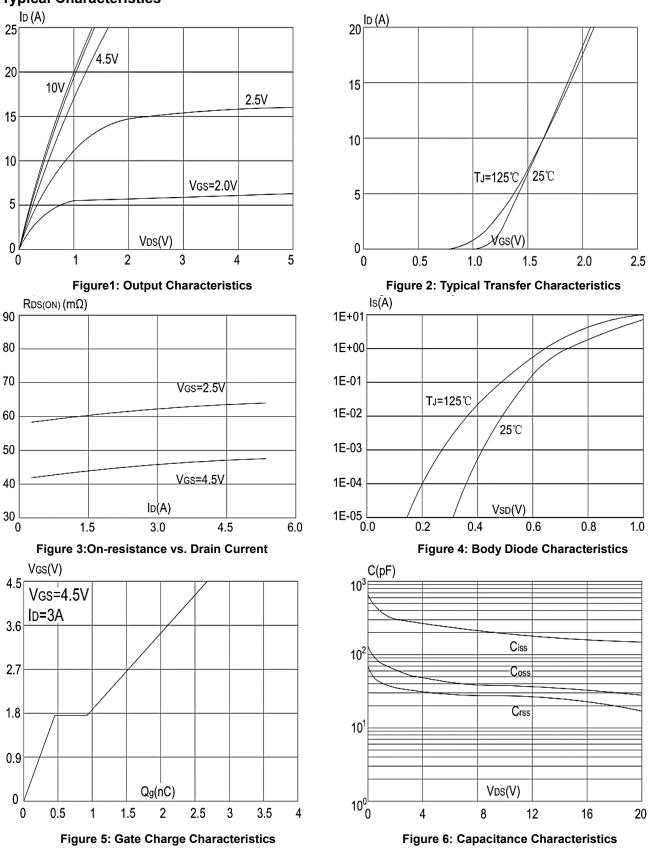
3 The power dissipation is limited by 150° C junction temperature

4. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

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Typical Characteristics

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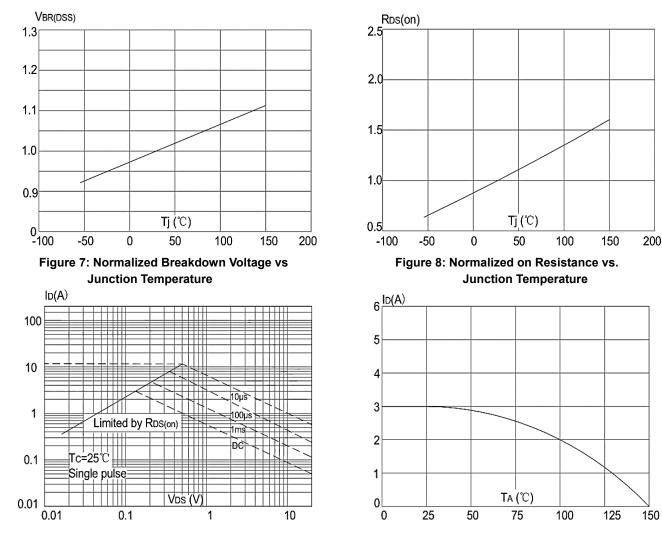
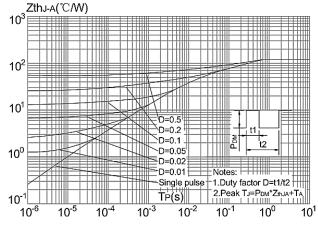


Figure 9: Maximum Safe Operating Area





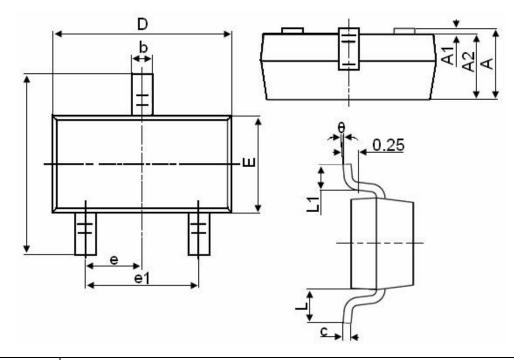


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Package Mechanical Data-SOT23-XC-Single



Symbol	Dimensions in Millimeters		
Symbol	MIN.	MAX.	
А	0.900	1.150	
A1	0.000	0.100	
A2	0.900	1.050	
b	0.300	0.500	
С	0.080	0.150	
D	2.800	3.000	
E	1.200	1.400	
E1	2.250	2.550	
е	0.95	0.950TYP	
e1	1.800	2.000	
L	0.550REF		
L1	0.300	0.500	
θ	0°	8°	

С

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Edition	Date	Change
Rve1.0	2022/1/1	Initial release
Rve1.1	2023/2/17	Reduce RDS(on)

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